IPC - ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				der both le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1					Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Mater					als and Mfg	Informati	ion	
upplier Inform	ation						·							
Company name*			Company unique ID			Ţ	Unique ID Authority				Response Date*			
nsemi											2025-05-03			
Contact Name		Title - Contact			F	Phone - Contact*				Email - Contact*				
Product-Env-Stewar	rds		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
uthorized Represer	ntative*	Title - Representative			F	Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com			
Requester	Requester Item Number		Number	Mfr Item Name			Effective Date	Version	n Manufacturing Site		W	eight*	UOM	Unit Type
		2N7002DW FET 6		FET 60V 2.0 mOhm SC88			2025-05-03		C	CN1		759	mg	Each
	Process Informatio		arminal Reso	Alloy	STD-020 MSL 1	Pating	Dank Droo	ace Rody T	amnaratur	a May Time at Pools	Tamparatur	a Numb	per of Reflow Cyc	Jac
			Terminal Base Alloy J-STI CU Alloy 1		31D-020 MSL I	Kaung	Peak Process Body Tempe 260 C		C				bei of Reflow Cyc	108
•	i (Sii) - aimeaieu	C	U Alloy	1			200		<u> </u> C	30	seconds	3		
omments	me at neels townst	duning sel	domina ia 10-1	10 seconds										
	me at peak temperature													
r more informatio	on regarding material co	mposition p	olease refer to	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its uppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.148	mg	Supplier	Silicon (Si)	7440-21-3		0.148	mg
Lead Frame	2.087	mg	В	Nickel (Ni)	7440-02-0		0.7576	mg
			Supplier	Iron (Fe)	7439-89-6		1.0477	mg
			Supplier	Copper (Cu)	7440-50-8		0.2817	mg
Mold Compound-Black	3.224	mg	Supplier	Boron zinc hydroxide oxide	138265-88-0		0.0967	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0161	mg
			Supplier	2,4,6-triamino-s-triazincompd.withs-triazine-triol	37640-57-6		0.0967	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.5792	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0322	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.2579	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.1451	mg
Plating	0.274	mg	Supplier	Tin (Sn)	7440-31-5		0.274	mg
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg